

# Journal of Vibration Testing and System Dynamics

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## Editors

### Jan Awrejcewicz

Department of Automation, Biomechanics and Mechatronics  
The Lodz University of Technology  
1/15 Stefanowskiego Str., BLDG A22, 90-924 Lodz, Poland  
Email: jan.awrejcewicz@p.lodz.pl

### C. Steve Suh

Department of Mechanical Engineering  
Texas A&M University  
College Station, TX 77843-3123, USA  
Email: ssuh@tamu.edu

### Xian-Guo Tuo

School of Automation & Information Engineering  
Sichuan University of Science and Engineering  
Zigong, Sichuan, 643000, China  
Email: tuoxianguo@suse.edu.cn

### Jiazhong Zhang

School of Energy and Power Engineering  
Xi'an Jiaotong University  
Xi'an, 710048, China  
Email: jzzhang@mail.xjtu.edu.cn

## Associate Editors

### Jinde Cao

School of Mathematics  
Southeast University  
Sipailou 2#  
Nanjing, 210096, China  
Email: jdcao@seu.edu.cn

### Yoshihiro Deguchi

Department of Mechanical Engineering  
Tokushima University  
2-1 Minamijyousanjima-cho  
Tokushima 770-8506, Japan  
Email: ydeguchi@me.tokushima-u.ac.jp

### Yu Guo

McCoy School of Engineering  
Midwestern University  
3410 Taft Boulevard  
Wichita Falls, TX 76310, USA  
Email: yu.guo@mwsu.edu

### Hamid R. Hamidzadeh

Department of Mechanical and  
Manufacturing Engineering  
Tennessee State University  
Nashville, TN 37209-1561, USA  
Email: hhamidzadeh@tnstate.edu

### Jianzhe Huang

Department of Power and  
Energy Engineering  
Harbin Engineering University  
Harbin, 150001, China  
Email: jianzhe@hrbeu.edu.cn

### Meng-Kun (Jason) Liu

Department of Mechanical Engineering  
National Taiwan University of Science  
and Technology  
Taipei, Taiwan  
Email: mkliu@mail.ntust.edu.tw

### Zhi-Ke Peng

School of Mechanical Engineering  
Shanghai Jiao Tong University  
Shanghai, P. R. China 200240  
Email: z.peng@sjtu.edu.cn

### Alexander P. Seyranian

Institute of Mechanics  
Moscow State Lomonosov University,  
Michurinsky pr. 1, 119192  
Moscow, Russia  
Email: aseyranian@mail.ru

### Dimitry Volchenkov

Department of Mathematics & Statistics  
Texas Tech University  
1108 Memorial Circle  
Lubbock, TX 79409, USA  
Email: dr.volchenk@gmail.com

### Baozhong Yang

Schlumberger Smith Bits  
1310 Rankin Rd  
Houston, TX 77073, USA  
Email: bzyang@gmail.com

### Guirong (Grace) Yang

Department of Civil, Architectural and  
Environmental Engineering  
Missouri University of Science and  
Technology  
Rolla, MO 65409, USA  
Email: yang@mst.edu

### Shudong Yu

Department of Mechanical and Industrial  
Engineering  
Ryerson University  
Toronto, Ontario  
M5B 2K3 Canada  
Email: syu@ryerson.ca

## Editorial Board

### Farbod Alijani

Department of Precision and  
Microsystems Engineering  
Delft University of Technology  
The Netherlands  
Email: F.Alijani@tudelft.nl

### Nyesunthi Apiwattanalungarn

Department of Mechanical Engineering  
Kasetsart University  
JatuJak Bangkok 10900  
Thailand  
Email: fengpra@ku.ac.th

### Junqiang Bai

School of Aeronautics  
Northwestern Polytechnical University  
Xi'an, P. R. China  
Email: junqiang@nwpu.edu.cn

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Editors

Jan Awrejcewicz

C. Steve Suh

Xian-Guo Tuo

Jiazhong Zhang



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**Vibration Testing and System Dynamics** is an interdisciplinary journal serving as the forum for promoting dialogues among engineering practitioners and research scholars. As the platform for facilitating the synergy of *system dynamics, testing, design, modeling, and education*, the journal publishes high-quality, original articles in the theory and applications of dynamical system testing. The aim of the journal is to stimulate more research interest in and attention for the interaction of theory, design, and application in dynamic testing. Manuscripts reporting novel methodology design for modelling and testing complex dynamical systems with nonlinearity are solicited. Papers on applying modern theory of dynamics to real-world issues in all areas of physical science and description of numerical investigation are equally encouraged. Progress made in the following topics are of interest, but not limited, to the journal:

- Vibration testing and design
- Dynamical systems and control
- Testing instrumentation and control
- Complex system dynamics in engineering
- Dynamic failure and fatigue theory
- Chemical dynamics and bio-systems
- Fluid dynamics and combustion
- Pattern dynamics
- Network dynamics
- Control signal synchronization and tracking
- Bio-mechanical systems and devices
- Structural and multi-body dynamics
- Flow or heat-induced vibration
- Mass and energy transfer dynamics
- Wave propagation and testing
- Acoustics

No length limitations for contributions are set, but only concisely written manuscripts are published. Brief papers are published on the basis of Technical Notes. Discussions of previous published papers are welcome.

## Peer Review

*Journal of Vibration Testing and System Dynamics* adopts the traditional blind-review policy in which the reviewers' names are concealed for submission author(s) for free submission. Each submitted manuscript is reviewed at least two referees in appropriate fields. In addition, the editorial board members' recommendation or established experts' recommendation publication are welcome.

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**Mohamed Belhaq**

Laboratory of Mechanics  
University Hassan II-Casablanca  
Casablanca, Morocco  
Email: mbelhaq@yahoo.fr

**Frank Z. Feng**

Department of Mechanical and  
Aerospace Engineering  
University of Missouri  
Columbia, MO 65211, USA  
Email: FengF@missouri.edu

**Krzysztof Kecik**

Department of Applied Mechanics  
Lublin University of Technology  
Nadbystrzycka, Lublin, Poland  
Email: k.kecik@pollub.pl

**Liansheng Li**

College of Mechanical and Electrical  
Engineering  
Qingdao University of Science and  
Technology  
NO.99 Songling Road, Qingdao 266061,  
P.R. China  
Email: [lianshengli@126.com](mailto:lianshengli@126.com)

**Yan Liu**

School of Mechanical Engineering  
Northwestern Polytechnical University  
Xi'an, P. R. China  
Email: liuyan@nwpu.edu.cn

**Jihong Wen**

Institute of Mechatronical Engineering  
National University of Defense  
Technology  
Changsha, Hunan, P.R. China  
Email: wenjihong@nudt.edu.cn

**Xingzhong Xiong**

School of Automation & Information  
Engineering  
Sichuan University of Science and  
Engineering  
Zigong, Sichuan, P. R. China  
Email: xzxiong@suse.edu.cn

**Zhaobo Chen**

School of Mechatronics Engineering  
Harbin Institute of Technology Harbin  
150001, P.R. China  
Email: chenzb@hit.edu.cn

**Fotios Georgiadis**

School of Engineering  
University of Lincoln  
Lincolnshire LN6 7TS  
United Kingdom  
Email: fgeorgiadis@lincoln.ac.uk

**Ryoichi Kurose**

Department of Mechanical Engineering  
and Science  
Kyoto University, Kyoto, Japan  
Email: kurose@mech.kyoto-u.ac.jp

**Ke Li**

Schlumberger Technology  
200 Gillingham Lane  
Sugarland, TX 77478, USA  
Email: KLi2@slb.com

**Diego Orlando**

Department of Civil Engineering  
Universidade do Estado do Rio de  
Janeiro, Rio de Janeiro, Brazil  
Email: dgorlando@gmail.com

**Lianhua Wang**

College of Civil Engineering  
Hunan University  
Changsha, Hunan, P.R. China  
Email: Lhwang@hnu.edu.cn

**Guozhi Yao**

Modine Manufacturing Company  
Racine, WI 53403, USA  
Email: G.Yao@na.modine.com

**Francesco Clementi**

Department of Civil and Buildings  
Engineering and Architecture  
Polytechnic University of Marche  
Ancona, Italy  
Email: francesco.clementi@univpm.it

**Lei Guo**

School of Automation Science and  
Electrical Engineering  
Beihang University  
Beijing, P.R. China  
Email: lguo@buaa.edu.cn

**Stefano Lenci**

Dipartimento di Ingegneria Civile  
Edile e Architettura, Universita'  
Politecnica delle Marche via Brecce  
Bianche, 60131 ANCONA, Italy  
Email: [lenci@univpm.it](mailto:lenci@univpm.it)

**Xiaofeng Liao**

School of Electronic Information  
Engineering  
Southwest University  
Chongqing, P.R. China  
Email: xfliao@cqu.edu.cn

**Laura Ruzziconi**

Dipartimento di Architettura  
Costruzioni e Strutture  
Università Politecnica delle Marche  
Ancona, Italy  
Email: laura.ruzziconi@uniecampus.it

**Hiroaki Watanabe**

Department of Mechanical Engineering  
Kyushu University  
Nishi-ku, Fukuoka 819-0395, Japan  
Email: whiroaki@mech.kyushu-u.ac.jp

**Weinian Zhang**

School of Mathematics,  
Sichuan University  
Chengdu, Sichuan, P.R. China  
Email: wnzhang@scu.edu.cn